

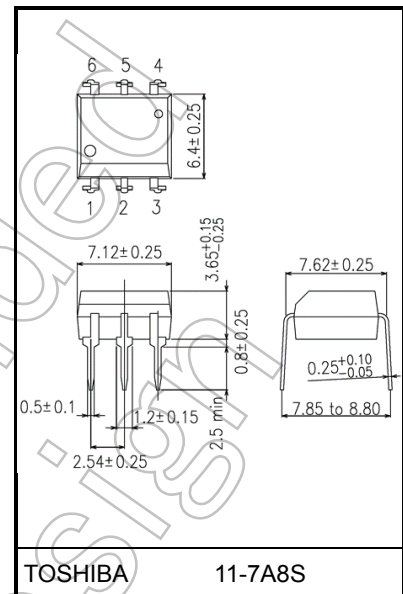
TLP630

Programmable Controllers
 AC / DC-Input Module
 Telecommunication

The TOSHIBA TLP630 consists of a photo-transistor optically coupled to two infrared emitting diode connected inverse parallel in a six lead plastic DIP package.

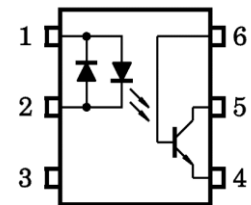
- Collector-emitter voltage: 55 V (min)
- Current transfer ratio: 50% (min)
 Rank GB: 100% (min)
- Isolation voltage: 5000 Vrms (min)
- UL-recognized: UL1577, File No.E67349

Unit: mm



Weight: 0.4 g (typ.)

Pin Configurations (top view)



- 1 : ANODE, CATHODE
- 2 : CATHODE, ANODE
- 3 : N.C.
- 4 : EMITTER
- 5 : COLLECTOR
- 6 : BASE

Start of commercial production
 1983-05

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	$I_{F(RMS)}$	60	mA
	Forward current derating (Ta ≥ 39°C)	$\Delta I_F / ^\circ C$	-0.7	mA / °C
	Peak forward current (100 μs pulse, 100 pps)	I_{FPT}	±1	A
	Diode power dissipation	P_D	100	mW
	Diode power dissipation derating (Ta ≥ 39 °C)	$\Delta P_D / ^\circ C$	-1.2	mW/°C
Detector	Collector-emitter voltage	V_{CEO}	55	V
	Collector-base voltage	V_{CBO}	80	V
	Emitter-collector voltage	V_{ECO}	7	V
	Emitter-base voltage	V_{EBO}	7	V
	Collector current	I_C	50	mA
	Power dissipation	P_C	150	mW
	Power dissipation derating (Ta ≥ 25°C)	$\Delta P_C / ^\circ C$	-1.5	mW / °C
Operating temperature range		T_{opr}	-55 to 100	°C
Storage temperature range		T_{stg}	-55 to 125	°C
Lead soldering temperature (10 s)		T_{sol}	260	°C
Junction temperature		T_j	125	°C
Total package power dissipation		P_T	250	mW
Total package power dissipation derating (Ta ≥ 25°C)		$\Delta P_T / ^\circ C$	-2.5	mW / °C
Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)		BV_S	5000	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: LED side pins Shorted together and DETECTOR side pins shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Supply voltage	V_{CC}	—	5	24	V
Forward current	$I_{F(RMS)}$	—	16	25	mA
Collector current	I_C	—	1	10	mA
Operating temperature	T_{opr}	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

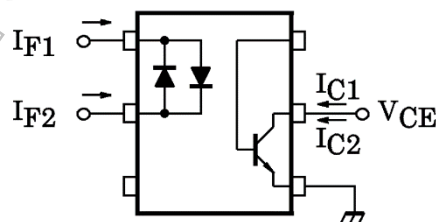
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
	Forward current	I _F	V _F = 0.7 V	—	2.5	10	μA
	Capacitance	C _T	V = 0 V, f = 1 MHz	—	60	—	pF
Detector	Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C = 0.5 mA	55	—	—	V
	Emitter-collector breakdown voltage	V _{(BR)ECO}	I _E = 0.1 mA	7	—	—	V
	Collector-base breakdown voltage	V _{(BR)CBO}	I _C = 0.1 mA	80	—	—	V
	Emitter-base breakdown voltage	V _{(BR)EBO}	I _E = 0.1 mA	7	—	—	V
	Collector dark current	I _{CEO}	V _{CE} = 24 V	—	10	100	nA
				V _{CE} = 24 V, Ta = 85 °C	—	2	50
	Collector dark current	I _{CBO}	V _{CB} = 10 V	—	0.1	—	nA
Capacitance (collector to emitter)	C _{CE}	V = 0 V, f = 1MHz	—	10	—	pF	

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	I _C / I _F	I _F = ±5 mA, V _{CE} = 5 V Rank GB	50	—	600	%
			100	—	600	
Saturated CTR	I _C / I _{F(sat)}	I _F = ±1 mA, V _{CE} = 0.4 V Rank GB	—	60	—	%
			30	—	—	
Base photo-current	I _{PB}	I _F = ±5 mA, V _{CB} = 5 V	—	10	—	μA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 2.4 mA, I _F = ±8 mA	—	—	0.4	V
Off-state collector current	I _{C(off)}	V _F = ±0.7 V, V _{CE} = 24 V	—	1	10	μA
CTR symmetry	I _{C(ratio)}	I _C (I _F = -5 mA) / I _C (I _F = +5 mA) (Note 1)	0.33	1	3	—

Note 1:

$$I_{C(\text{ratio})} = \frac{I_{C2}(I_F = I_{F2}, V_{CE} = 5V)}{I_{C1}(I_F = I_{F1}, V_{CE} = 5V)}$$



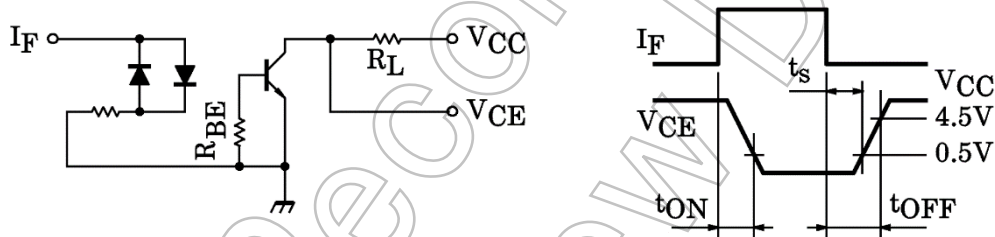
Isolation Characteristics (Ta = 25°C)

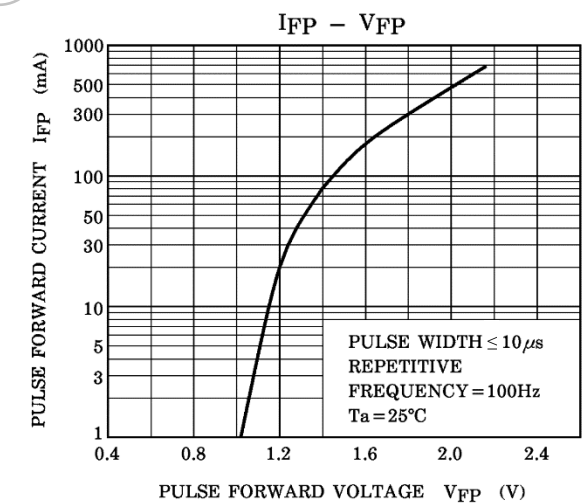
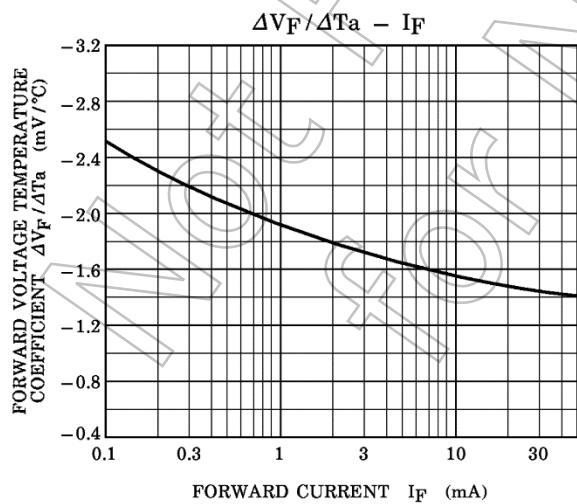
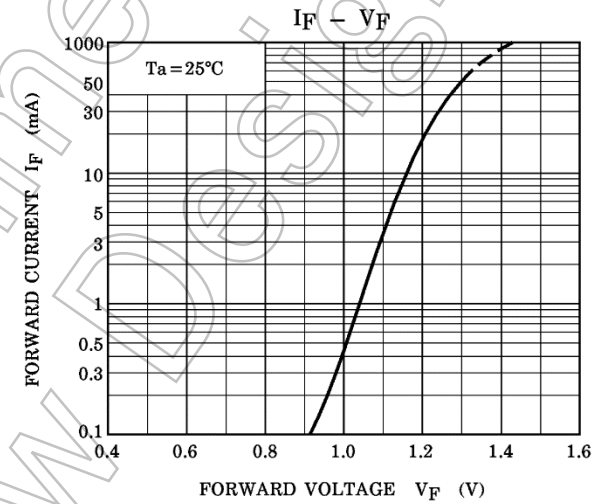
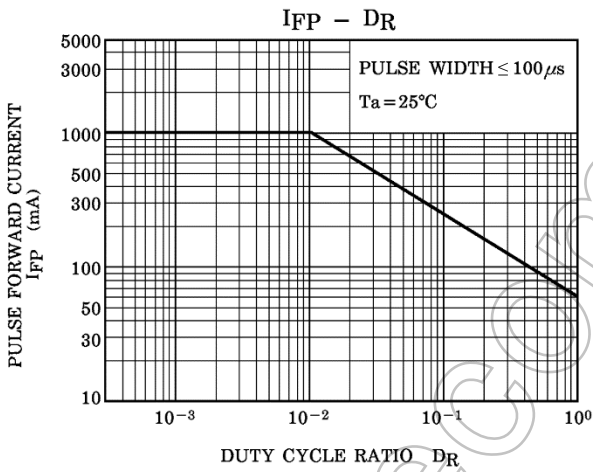
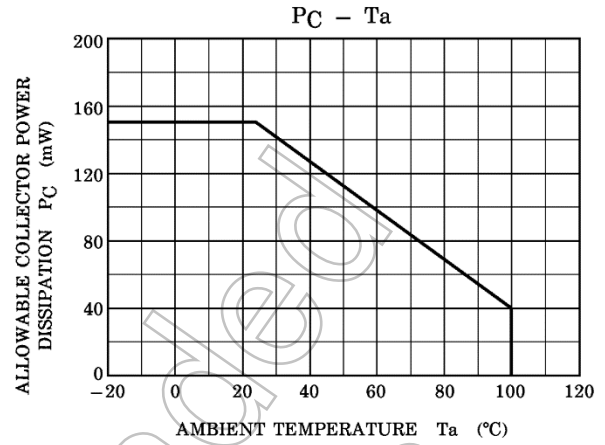
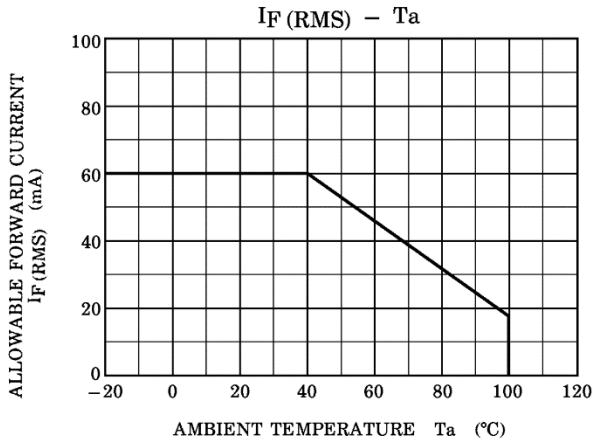
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance (input to output)	C _S	V _S = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	—	Ω
Isolation voltage	BV _S	AC, 60 s	5000	—	—	V _{rms}

Switching Characteristics (Ta = 25°C)

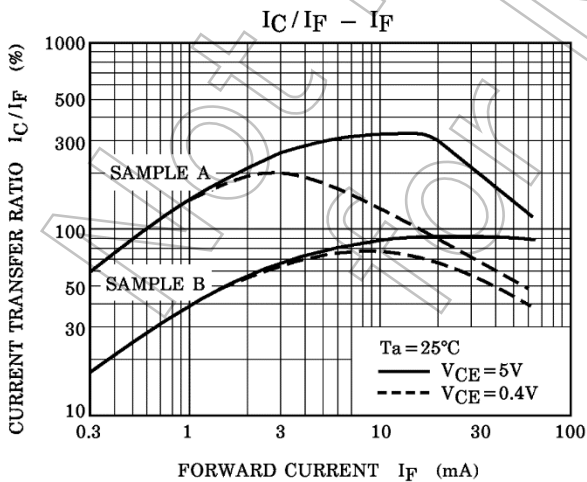
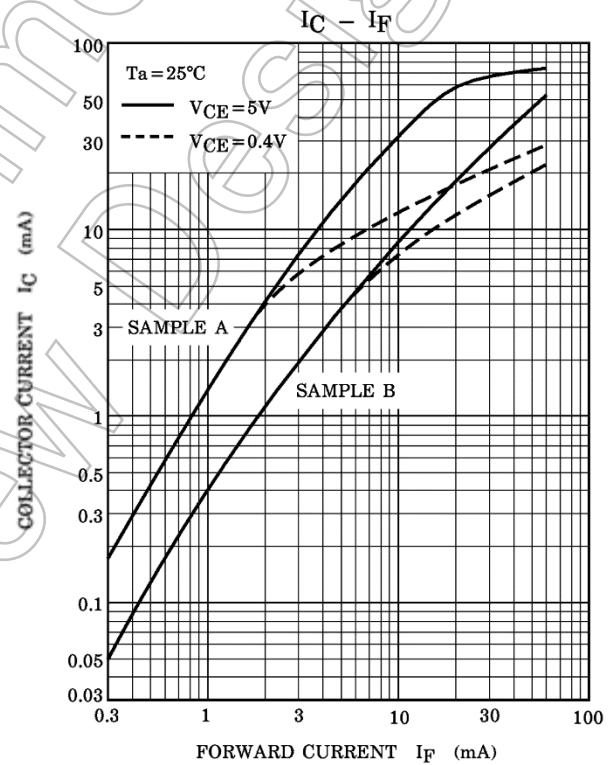
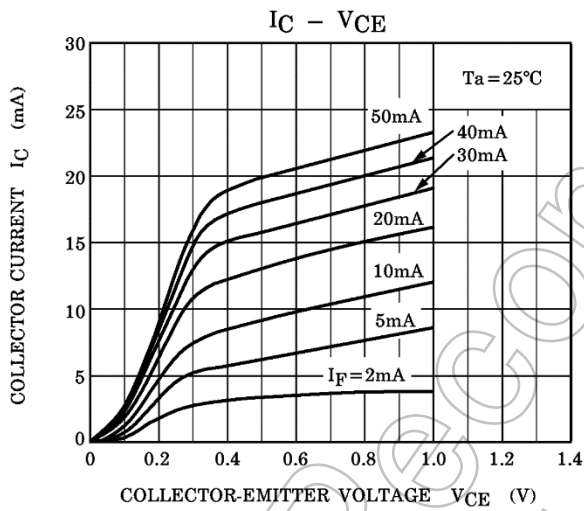
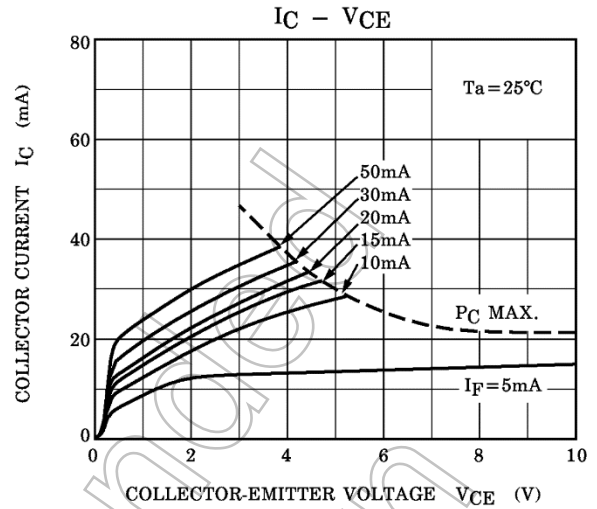
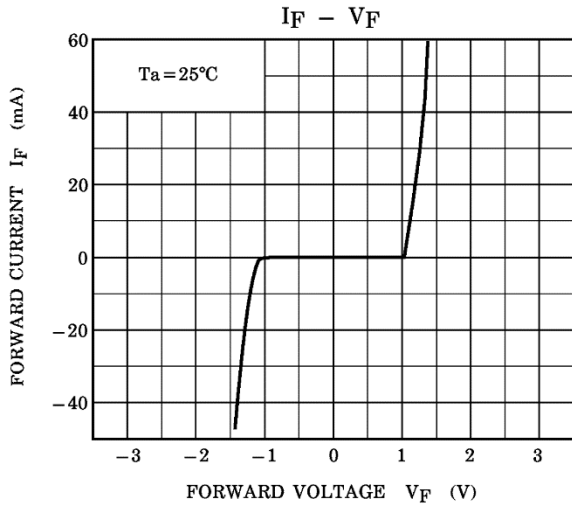
Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Rise time	t _r	V _{CC} = 10V, I _C = 2mA R _L = 100 Ω	—	2	—	μs
Fall time	t _f		—	3	—	
Turn-on time	t _{ON}		—	3	—	
Turn-off time	t _{OFF}		—	3	—	
Turn-on time	t _{ON}	R _L = 1.9 kΩ (Fig. 1) R _{BE} = OPEN V _{CC} = 5 V, I _F = ±16 mA	—	2	—	μs
Storage time	t _s		—	15	—	
Turn-off time	t _{OFF}		—	25	—	
Turn-on time	t _{ON}	R _L = 1.9 kΩ (Fig. 1) R _{BE} = 220 kΩ, V _{CC} = 5 V I _F = ±16 mA	—	2	—	μs
Storage time	t _s		—	12	—	
Turn-off time	t _{OFF}		—	20	—	

Fig. 1: Switching time test circuit

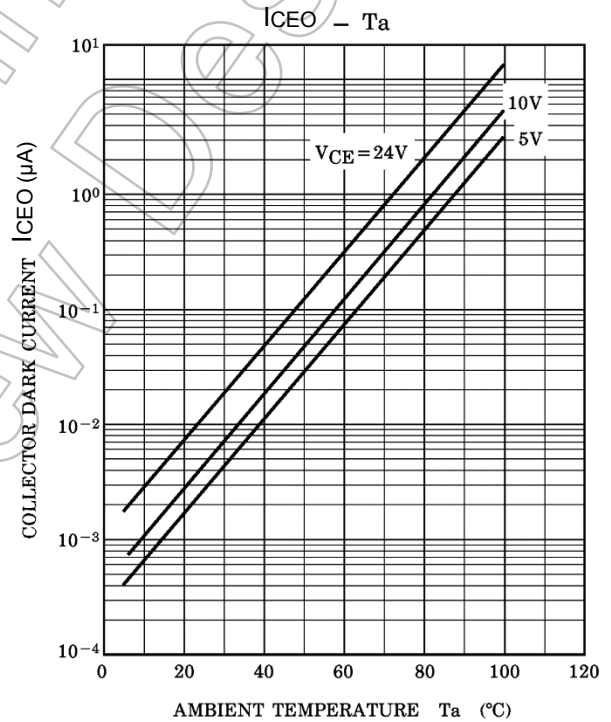
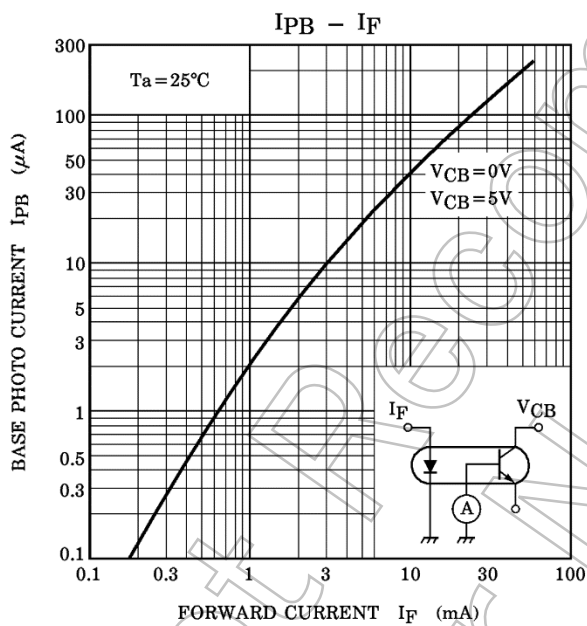
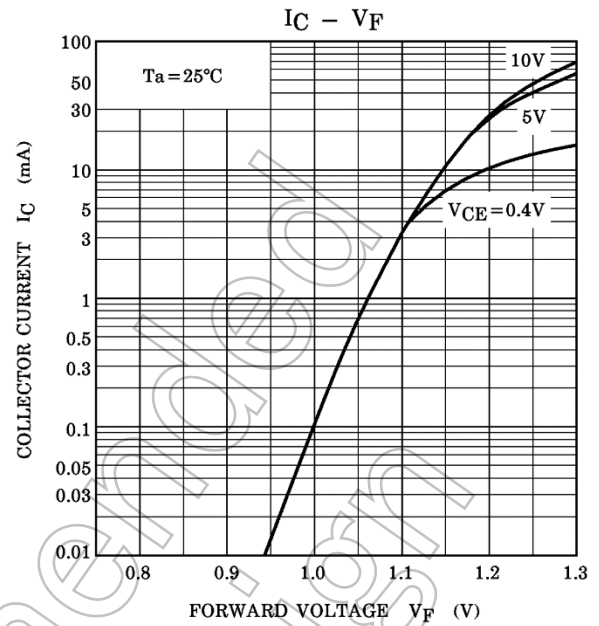
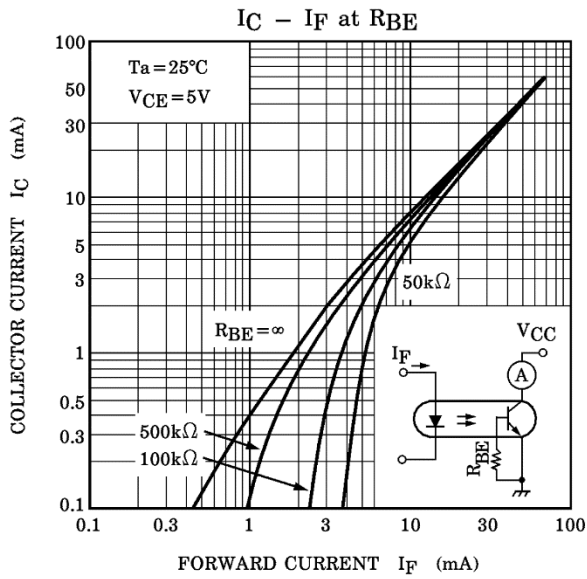




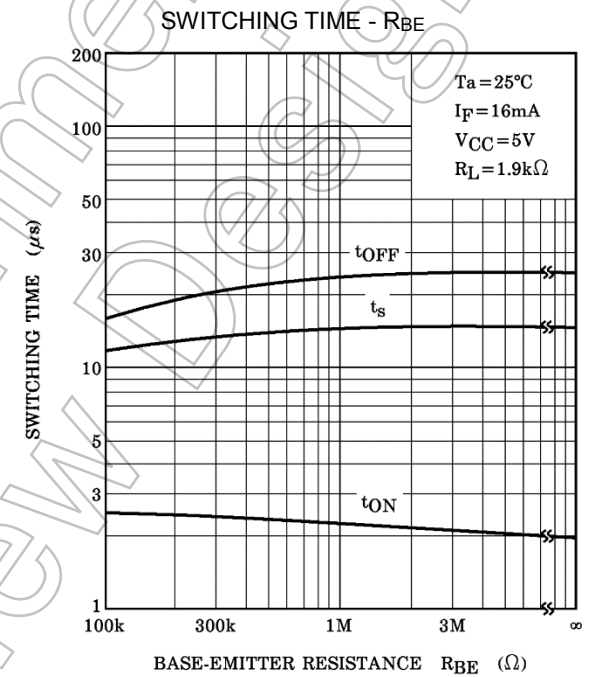
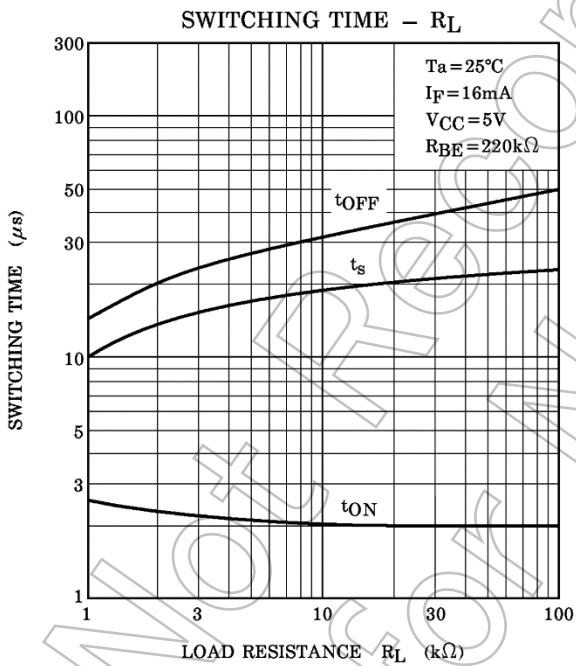
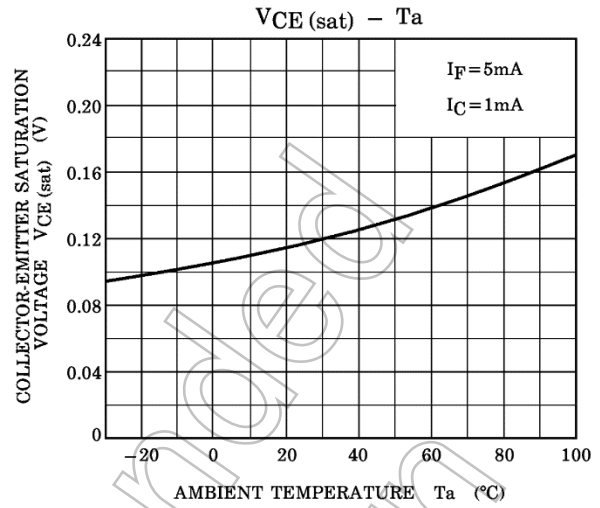
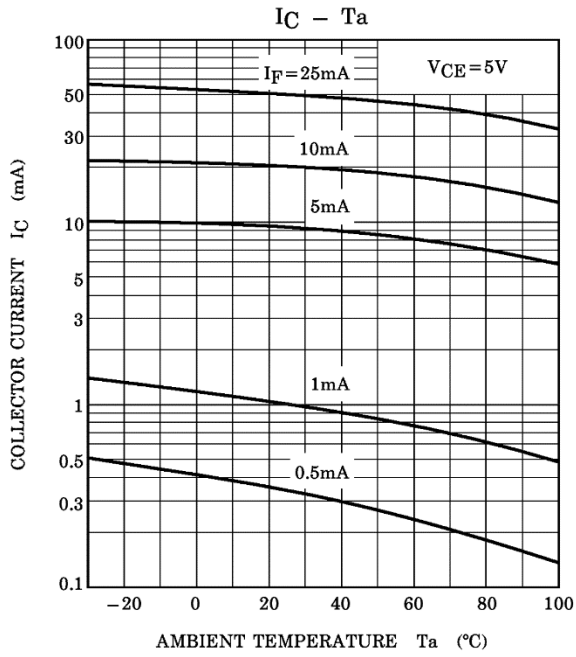
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